nexperia

Quarterly Reliability Monitoring Results

Quarters: Q1/2021 to Q4/2021

Based on structural similarity

Supplier		User Part Number				
Nexperia B.V.		PMEG4010CPA				
Name of Laboratory		Part Description				
		Nexperia DHAM	Schottky			
Assembly reliability labs		MCD package				
Based on AEC-Q101 Test		Test Conditions	Duration	# Lots	# Quantity	# Rejects
	TEST					
	Pre- and Post-Stress					
# E1	Electrical Test	Tamb = 25 °C	N/A	see below	all parts	see below
		JESD22-A113 Bake Tamb = 125 °C	24 hours			
	PC	Bake Tamb = $125 ^{\circ}$ C Soak Tamb = $85 ^{\circ}$ C, RH = 85%	24 nours 168 hours			
# A1	Preconditioning	Reflow soldering	3 cycles	113	9040	0
		MIL-STD-750-1		110	5010	0
	HTRB	M1038 Method A				
	High Temperature Reverse	Tj = Tjmax, Vr = 100% of max. datasheet				
# B1	Bias	reverse voltage ^[1]	1000 hours	116	9280	0
	тс	JESD22-A104				
# A4	Temperature Cycling	-65 °C to Tjmax, not to exceed 150°C	1000 cycles	28	2240	0
		JESD22-A102				
# AD - It	AC Autoclave	Tamb = 121 °C, RH = 100 % Pressure = 205 kPa (29.7 psia)	06 haven	20	2240	0
# A3 alt	Autoclave	Plessule = 203 kPa (29.7 psia)	96 hours	28	2240	0
	H3TRB	JESD22-A101				
	High Humidity High	Tamb = $85 ^{\circ}$ C, RH = 85% , VR = 80% of				
# A2 alt		rated reverse voltage ^{[1], [2]}	1000 hours	28	2240	0
		MIL-STD-750 Method 1037				
	IOL	ton = toff, devices powered to insure ΔTj =				
# A5	Intermittent Operating Life	100 °C for 15000 cycles	1000 hours	29	2320	0
	RSH	JESD22-A111				
# C8	Resistance to Solder Heat	260 °C ± 5 °C	10 s	n.a.	n.a.	n.a.
	SD Soldarabilita	1 CTD 002				
# C10	Solderability	J-STD-002		63	630	0

[1] The physical limitations of Schottky diodes have to be considered (thermal runaway).

[2] The maximum applied voltage is limited by test chamber set up and does not exceed 115V.

Calculation of FIT and MTTF

Test considered for FIT calculation: High Temperature Reverse Bias (HTRB, Test #B1)

Confidence level 60%, derated to 55 °C, activation energy 0.7 eV, test time 168 to 1000 hours

Nexperia	
DUAM	
DHAM Schottky 9280 0 0.46	2.19E+09

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